

## N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.021 at V <sub>GS</sub> = 10 V	18	3.8 nC		
30	0.025 at V <sub>GS</sub> = 4.5 V	17	3.6110		

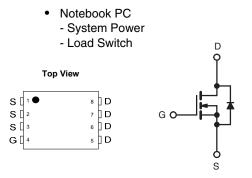




#### FEATURES

- Halogen-free According to IEC 61249-2-21
- Trench Power MOSFET
- 100 % R<sub>a</sub> Tested

#### **APPLICATIONS**



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	30	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		18 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		11 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	9 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		7 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	35	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1-	12 <sup>a</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.7 <sup>b, c</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	5		
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	1.25	mJ	
	T <sub>C</sub> = 25 °C		15.6		
Maximum Bowar Discinction	T <sub>C</sub> = 70 °C	P <sub>D</sub>	10	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	'D	3.2 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C		2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temper		260			

#### THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	32	39	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	6.5	8	0/11		

Notes:

a. Package Limited.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 81 °C/W.

e. The DFN 3X 3 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

f. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

COMPLIANT

<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted							
Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V		
$\Delta V_{DS}/T_{J}$	In - 250 µA		35		mV/°C		
$\Delta V_{GS(th)}/T_J$	10 - 200 μΛ		- 4.5				
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.0		2.5	V		
I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA		
I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA		
				5			
I <sub>D(on)</sub>		20			A		
R <sub>DS(on)</sub>	**				Ω		
20(01)			0.025				
9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 7.8 \text{ A}$		17		S		
			1	1	-		
			435		pF		
	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		95				
C <sub>rss</sub>			42				
Qg	$V_{\rm DS}$ = 15 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 7.8 A		8	12	nC		
Q <sub>as</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7.8 A		3.8 1.4	0			
			1.1				
	f = 1 MHz	1.5	3.2	4.5	Ω		
			15	25			
t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{I}} = 2.4 \Omega$		12	20	-		
t <sub>d(off)</sub>	$I_D \cong 6.3 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		13	20			
t <sub>f</sub>			10	15			
t <sub>d(on)</sub>			5	10	ns		
t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 2.4 $\Omega$		10	15			
	$I_D \cong 6.3 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		15	25			
t <sub>f</sub>			10	15			
		I		1			
ا <sub>S</sub>	T <sub>C</sub> = 25 °C		12				
			-	35	A		
	I <sub>S</sub> = 6.3 A, V <sub>GS</sub> = 0 V		0.8	1.2	V		
			15	25	ns		
			7	12	nC		
	I <sub>F</sub> = 6.3 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		9		ns		
t <sub>b</sub>			6				
	$\begin{tabular}{ c c c c } \hline Symbol \\ \hline $V_{DS}$ \\ \hline $\Delta V_{DS} / T_J$ \\ \hline $\Delta V_{GS}(th) / T_J$ \\ \hline $\Delta V_{GS}(th) / T_J$ \\ \hline $V_{GS}(th) / T_J$ \\ \hline $V_{GS}(th) / T_J$ \\ \hline $V_{GS}(th) / T_J$ \\ \hline $I_{DSS}$ \\ \hline $I_{Ciss}$ \\ \hline $C_{iss}$ \\ \hline $C_{iss}$ \\ \hline $C_{iss}$ \\ \hline $C_{iss}$ \\ \hline $C_{oss}$ \\ \hline $C_{ass}$ \\ \hline $C$	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline \Delta V_{DS} / T_J & I_D = 250 \ \mu A \\ \hline \Delta V_{GS}(th) / T_J & V_{DS} = V_{GS}, \ I_D = 250 \ \mu A \\ \hline V_{QS}(th) & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ T_J = 55 \ ^{\circ}C \\ \hline I_{D}(on) & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} = 10 \ V, \ I_D = 7.8 \ A \\ \hline V_{DS} = 10 \ V, \ I_D = 7.8 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A \\ \hline V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 7.8 \ A \\ \hline Q_{gd} & V_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 7.8 \ A \\ \hline U_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 7.8 \ A \\ \hline U_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 7.8 \ A \\ \hline U_{DS} = 15 \ V, \ V_{GS} = 4.5 \ V, \ I_D = 7.8 \ A \\ \hline Q_{gd} & I_D \cong 6.3 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_d(on) & I_t \\ \hline I_d(on) & I_t \\ \hline I_D \cong 6.3 \ A, \ V_{GEN} = 4.5 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 6.3 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_D \cong 6.3 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_T \\ \hline I_D \cong 6.3 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline I_T \\ \hline I_T \\ \hline I_T \\ \hline V_{SD} & I_S = 6.3 \ A, \ V_{GS} = 0 \ V \\ \hline I_T \\ \hline I_F = 6.3 \ A, \ U_{CS} = 0 \ V \\ \hline I_T \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ V_{GS} = 0 \ V \\ \hline I_T \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{CS} = 0 \ V \\ \hline I_T \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{CS} = 0 \ V \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{CS} = 0 \ V \\ \hline I_T \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{CS} = 0 \ V \\ \hline I_T \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{CS} = 0 \ V \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{SS} = 0 \ V \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{SS} = 0 \ V \\ \hline V_{SD} \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{SS} = 0 \ V \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{SS} = 0 \ V \\ \hline V_{SD} \\ \hline I_S = 6.3 \ A, \ U_{SS} = 0 \ V \\ \hline I_S = 0 \ V \\ $	$\begin{tabular}{ c c c c } \hline Symbol & Test Conditions & Min. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 \\ \hline \Delta V_{DS} / T_J & I_D = 250 \ \mu A & 1.0 \\ \hline I_D = 250 \ \mu A & 1.0 \\ \hline V_{GS(th)} & V_{DS} = V_{GS} \ I_D = 250 \ \mu A & 1.0 \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 30 \ V, \ V_{GS} = 0 \ V & V_{DS} = 55 \ C & V_{DS} = 30 \ V, \ V_{GS} = 10 \ V & 20 \\ \hline V_{DS} = 30 \ V, \ V_{GS} = 0 \ V, \ I_D = 7.8 \ A & V_{GS} = 10 \ V, \ I_D = 7.8 \ A & V_{DS} = 10 \ V, \ I_D = 7.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ I_D = 7.8 \ A & V_{DS} = 15 \ V, \ V_{GS} = 10 \ V, \ 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Conditions & Min. Typ. \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A & 30 & 35 & 36 & 36 & 36 & 36 & 36 & 36 & 36$	$\begin{tabular}{ c c c c c c } \hline $\mathbf{Y}_{DS}$ & $V_{GS} = 0 \ V, \ I_D = 250 \ \mu A$ & $30$ & $-$4.5$ & $I_D = 250 \ \mu A$ & $-$4.5$ & $-$6.5$ & $-$		

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

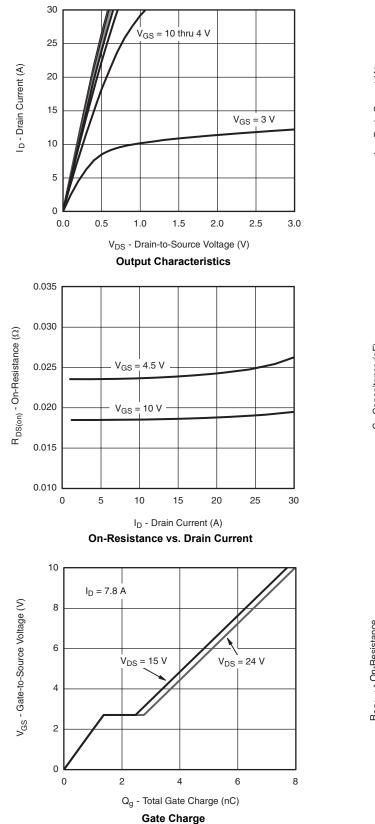
b. Guaranteed by design, not subject to production testing.

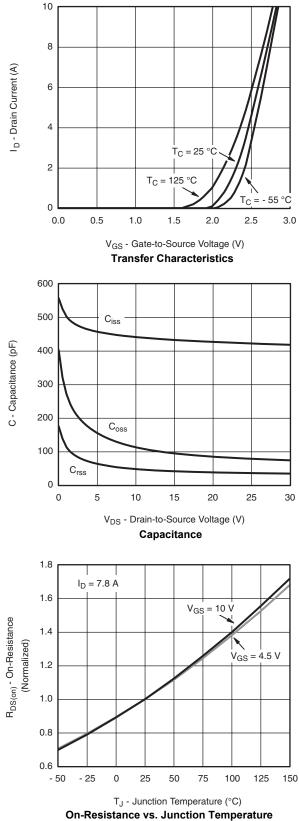
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

semi

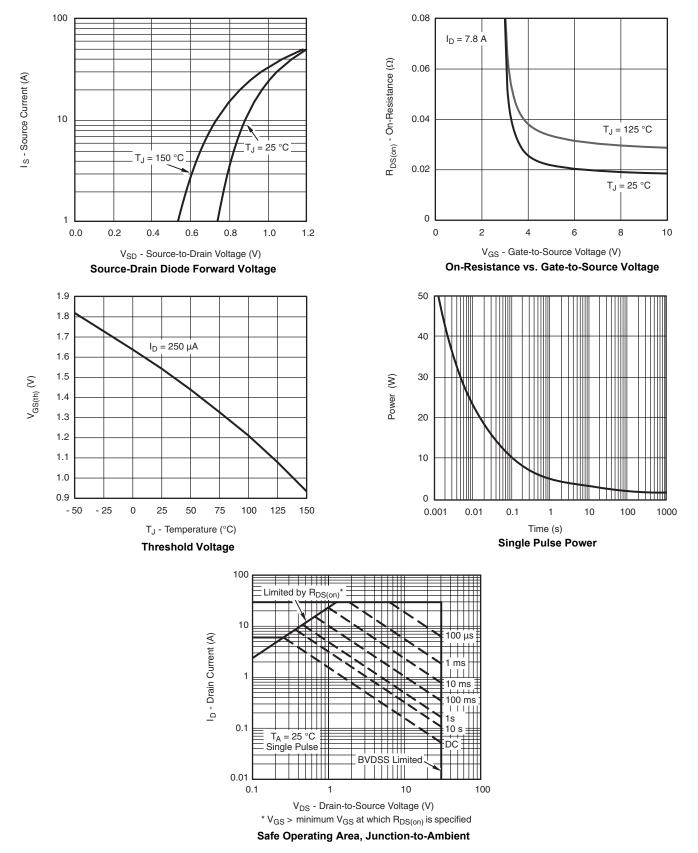
www.VBsemi.com



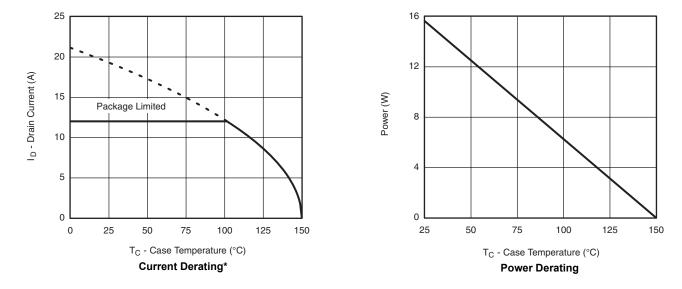




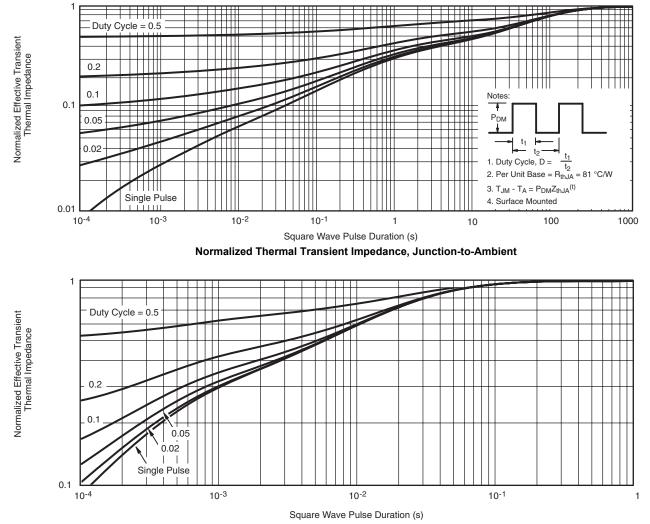








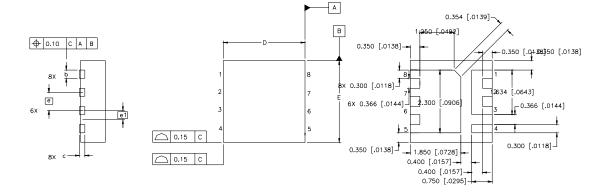
\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case



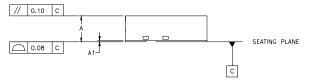
### **PQFN Package Details**



<u>SIDE VIEW</u>

TOP VIEW



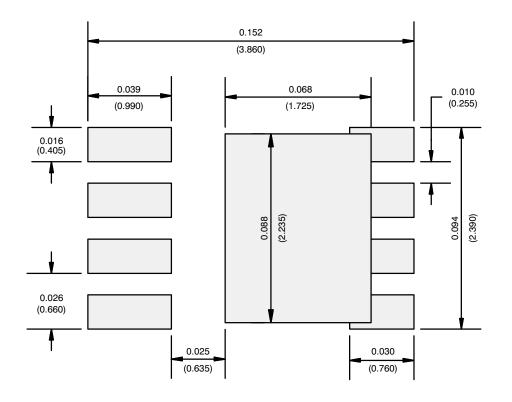


FRONT VIEW

DIM	INCH	IES	MILLIMETERS		
	MIN	MAX	MIN	MAX	
А	.0315	.0394	0.800	1.000	
A1	.0000	.0020	0.000	0.050	
b	.0098	.0138	0.250	0.350	
с	.0080	REF.	0.203 REF.		
D	.1181 BASIC		3.000 BASIC		
E	.1181 BASIC		3.000 BASIC		
е	.0262 BASIC		0.666	BASIC	
e1	.0131	BASIC	0.333	BASIC	



#### **RECOMMENDED MINIMUM PADS**



Recommended Minimum Pads Dimensions in Inches/(mm)



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